# INFORMATION IS CONFIDENTIAL AND IS DISCLOSED TO YOU ON CONDITION THAT NO THER DISCLOSURE IS MADE BY YOU OTHER THAN TO TYCO ELECTRONICS' ONNEL WITHOUT WRITTEN AUTHORISATION FROM TYCO ELECTRONICS.

### PRODUCT SPECIFICATIONS

### 108-51058

# 1mm Pitch FFC Connector, Dip Type (Non-ZIF Type)

### 1.0 SCOPE

### 1.1 Contents

This specification covers the requirements for product performance, test methods and quality assurance provisions of 1mm Pitch FFC Connector (Non-ZIF type).

The applicable product descriptions and part numbers are as follow:

Part Number	Part Description
X-84983-x	1mm FFC Connector, Dip, H
X-84984-x	1mm FFC Connector, Dip, V

Country of origin: Singapore

Production location: 26 Ang Mo Kio Industrial Park 2, Singapore 569507

UL File No.: E28476

### 2.0 Applicable Documents

The following documents form a part of this specification to the extent specified herein. In the event of conflict between the requirements of this specification and the product drawing, the product drawing shall take precedence.

### 2.1 Specifications

A. 501-51039 Qualification Test Report

### 3.0 Requirements

### 3.1 Design And Construction

Product shall be of the design, construction and physical dimensions specified on the applicable product drawing.

tyco	SPEC:	1mm Pitch FFC Connector A	ssemb	oly, Dip Type	108-51058		
Electronics	REV:	В	PRE:	Tan Vincent	SPEC No:		
	EC No:	D20060322213751_927113	APP:	Choo Wing Lian	PAGE:	1 of 6	

3.2 Materials

A. Solder Peg: Brass, 1 µm min thk Tin over

Nickel underplate

B. Receptacle Contact: Phosphor bronze, 1 µm min thk Tin over

Nickel underplate

C. Receptacle Housing:

Dip version: Glass-filled PBT, UL94V-0, White colour

3.3 Ratings

A. Voltage Rating: 125V AC
B. Current Rating: 1.0A

C. Operating & Storage

Temperature Rating: -20°C to +85°C

3.4 Performance And Test Descriptions

The product shall be designed to meet the electrical, mechanical and environmental performance requirements specified in Fig 1.

3.5 Test Requirements And Procedures Summary

Para	Test Items	Requirements	Procedures
3.5.1	Confirmation of product	Product shall meet the requirements of the applicable product drawing.	Visually, dimensionally and functionally inspected per applicable quality inspection plan before test, visually only after test.
		Electrica	nl .
3.5.2	Contact / Termination Resistance (TR)	30 mΩ Max. (Initial)	Measurement shall be made between each contact and mating cables to close circuit current of 10mA Max.
3.5.3	Insulation Resistance	1000 MΩ Min	Apply voltage 500V DC for 1 minute between adjacent contacts of mated connector.
3.5.4	Dielectric Strength	No creeping discharge, arching nor flashover shall occur. Current leakage: 0.5mA Max.	500V AC (rms) for 1 minute. Test between adjacent contacts of mated connector.

Fig 1 (to be continued)

tuco /	Electronics	SPEC No:	REV:	PAGE:		
tytu į		108-51058	В	2 of 6		

Mechanical						
3.5.5	Vibration (Low Frequency)	No electrical discontinuity greater than 1µsec. shall	Subject mated connectors for 2 hours in each of 3 mutually perpendicular planes, with 1mA DC applied current.			
		occur. TR: 50 mΩ Max. (Final)	Amplitude: 1.52 mm Peak to Peak. Frequency: 10-55-10Hz shall be traversed in 1 minute			
3.5.6	Physical Shock	No electrical discontinuity greater than 1µsec. shall occur.	Subject mated connectors to following condition. 3 shocks shall be applied along 3 mutually perpendicular planes, with 1mA DC applied current.			
		TR: $50 \text{ m}\Omega$ Max. (Final)	Test Pulse: Halfsine shock Peak Value: 490m/s <sup>2</sup> (50G) Duration: 11 millisecond Total: 18 shocks			
3.5.7	Solderability	Wet solder coverage 90% Min, must show no voids, pin holes.	Dip soldertail into flux and examine.  JEDEC JESD22-B102D,Method 1			
3.5.8	Resistance To Soldering Heat for Dip Type	No physical damage shall occur.  Electrical characteristics shall be satisfied.	PCB thickness: 1.6mm  Solder Bath methods:  Pre-heat: 100~105° C;  Pre-heat time: 30 ±5 sec.  Solder temperature: 260 ±3° C;  Solder time: 5~6 sec., 2 cycles.			
			Soldering Iron Method: Solder temperature: 380 ± 10° C; Solder time: 3secs MIN			
3.5.9	FFC Mating And Un-mating Force	Mating Force: Pos. x 2.5 N Max. (Initial & after 30x) Un-mating Force: Pos. x 0.2 N Min.	Operation speed: 25.4 mm/minute  Measure the force required to mate and un-mate the connector.			
3.5.1	Durability (Repeated Mating & Un-mating)	(Initial & after 30x)  TR: $50 \text{ m}\Omega$ Max.  (Final)	Operation speed: 10 cycle/ minute No. Of cycles: 30 cycles.			

Fig 1 (to be continued)

tuco /	. Ele etre mise	SPEC No:	REV:	PAGE:
tytu /	Electronics	108-51058	В	3 of 6

		Environme	ntal						
3.5.11	Temperature Rise Vs Current	30°C Max.	Mated condition, apply test current of 1A DC to the circuit, measure the temperature rise by thermocouple probing on soldered areas of contacts, after the temperature become stabilised.						
3.5.12	Thermal Shock (Temperature Cycling)	TR: $50 \text{ m}\Omega$ Max. (Final)	Subject mated connectors to following condition, repeat for 5 cycles.						
				Step	Temperature	Time (min.)			
				1	-55 ± 5°C	30			
				2	+25 ± 5°C	10			
				3	+90 ± 5°C	30			
				4	+25 ± 5°C	10			
					Upon completion of the exposure period, test specimens shall be conditioned at ambient room conditions for 1 to 2 hours, after which the specified measurements shall be performed.				
3.5.13	Humidity, Steady State	Insulation resistance: 1000	Subject mated connectors to $90\sim95\%$ R.H., $40 \pm 2^{\circ}$ C for 96 hours.						
		MΩ Min. (Final).  Dielectric strength: must meet 3.5.4	Upon completion of the exposure period test specimens shall be conditioned at						
3.5.14	Salt Spray	TR: 50 mΩ Max.	Su	ıbject m	ated connectors to	0:			
		(Final)	Sa	ılt conce	entration: $5 \pm 1\%$				
			_	-	e: 48 hours				
			Ambient temperature: $35 \pm 2^{\circ}$ C.						
			Upon completion of the exposure period, test specimens shall be conditioned at ambient room conditions for 1 hour. The specified measurements shall be performed after salt deposits being removed.						

Fig 1 (to be continued)

tyco /	Flactronica	SPEC No:	REV:	PAGE:	
	Electronics	108-51058	В	4 of 6	

14TION IS CONFIDENTIAL AND IS DISCLOSED TO YOU ON CONDITION THAT NO	JRTHER DISCLOSURE IS MADE BY YOU OTHER THAN TO TYCO ELECTRONICS'	S.
NCON	TYCO	TRONIC
000	2	ELEC
7 O. C	THAN	LTYCO
ISCLOSE	OTHER	ON FROM
DISE	YOU	ISATIC
AL AN	BY	THOR
DENT	MADE	FEN AU
ž	IS	RIT
MATION IS CC	DISCLOSURE	SESONNEL WITHOUT WRITTEN AUTHORISATION FROM TYCO ELECTRONICS.
IIS INFORMA	RTHER	RSONNE

3.5.15	Temperature Life (Heat Resistance)	TR: 50 mΩ Max. (Final)	Subject mate connectors to 85±2°C for 250 hours.
			Upon completion of the exposure period, test specimens shall be conditioned at ambient room conditions for 1 hour, after which the specified measurements shall be performed.
3.5.16	Cold Resistance	TR: 50 mΩ Max. (Final)	Subject mated connectors to $-25\pm3^{\circ}$ C for 48 hours. Upon completion of the exposure period, test specimens shall be conditioned at ambient room conditions for 1 hour, after which the specified measurements shall be performed.

Fig 1 (End)

### **4.0 Quality Assurance Provisions**

### 4.1 Test Conditions

Unless otherwise specified, all the tests shall be performed in any combination of the following test conditions.

Temperature :  $15 \sim 35^{\circ}$  C Relative Humidity :  $25 \sim 85\%$ 

Atmosphere Pressure: 650 ~ 800 mm Hg

### 4.2 Test Specimens

- 4.2.1 The test specimens to be used for testing shall be confirming to the requirements of the applicable product drawing(s)
- 4.2.2 Unless otherwise specified, no sample shall be re-used.

tyco /	   Electronics	SPEC No:	REV:	PAGE:		
tybb /	Electionics	108-51058	В	5 of 6		

## 5.0 PRODUCT QUALIFICATION TEST SEQUENCE

Test	Test Group									
	1	2	3	4	5	6	7	8	9	10
Confirmation of Product	1,7	1,8	1,6	1,5	1,3	1,5	1,5	1,5	1,3	1,
										3
Termination Resistance		2,7	2,5	2,4		2,4	2,4	2,4		
Insulation Resistance	2,5									
Dielectric Strength	3,6									
Vibration			3							
Physical Shock			4							
Solderability									2	
Resistance to Soldering Heat										2
FFC Mating Force		3,6								
FFC Un-mating Force		4								
Durability		5								
Temperature Rise Vs Current					2					
Thermal Shock				3						
(Temperature Cycling)										
Humidity (Steady State)	4									
Salt Spray							3			
Temperature Life						3				
Cold Resistance								3		

Figure 2

THIS INFORMATION IS CONFIDENTIAL AND IS DISCLOSED TO YOU ON CONDITION THAT NO FURTHER DISCLOSURE IS MADE BY YOU OTHER THAN TO TYCO ELECTRONICS PERSONNEL, WITHOUT WRITTEN AUTHORISATION FROM TYCO ELECTRONICS.

tyco /	Electronics	SPEC No:	REV:	PAGE:
		108-51058	В	6 of 6